

Features & Benefits

- 💧 Excellent adhesive strength
- 💧 Excellent resistance to vibration
- 💧 Easy to use – no mixing required
- 💧 Low viscosity

Description

PERMABOND® ES560 is a single-part epoxy adhesive which flows when heated. It is unfilled and self-levelling, making it particularly suitable for electronics potting and encapsulation applications, as well as underfilling and reworking microchips. It withstands thermal cycling and has excellent shock resistance.

Physical Properties of Uncured Adhesive

Chemical composition	Epoxy Resin
Appearance	Uncured – white / opaque Cured – translucent
Viscosity @ 25°C	1,000-3,000 mPa.s (cp)
Specific gravity	1.2

Typical Curing Properties

Flow at high temperature	Free flow
Maximum gap fill	0.1 mm <i>0.004 in</i>
Cure speed (oven)*	Potting: 100°C (210°F): 30 minutes <u>plus</u> 120°C (250°F): 30 minutes. Bonding: 100° C (210°F): 60 minutes <u>or</u> 120°C (250°F): 40 minutes
Cure speed (induction)	<3 minutes

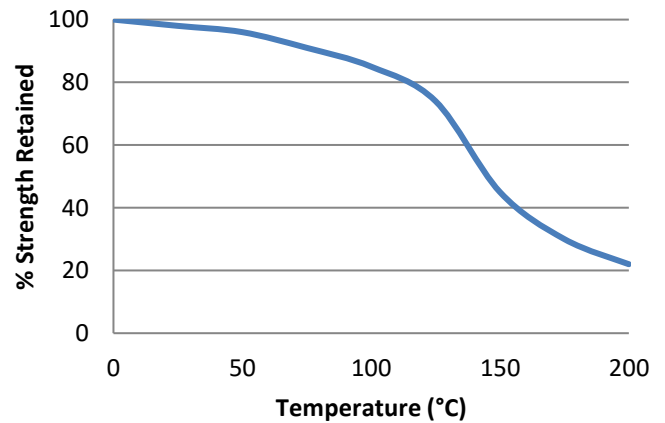
*Actual cure times will depend on the time it takes for the adhesive to reach this temperature - for example, large assemblies or a crowded oven will require longer to reach full cure. Alternative, quicker methods of curing include induction, hotplates, infrared lamps and hot-air guns.

Typical Performance of Cured Adhesive

Shear strength* (ISO4587)	Steel 14 - 20 N/mm ² <i>(2000-2900 psi)</i>
Peel strength (aluminium) (ISO4578)	40 N/25mm
Glass transition (Tg)	110°C
Hardness (ISO868)	80 Shore D
Coefficient of thermal expansion (+40-+100°C)	45 x 10 ⁻⁶ mm/mm/°C
Thermal conductivity	0.1 W/(m.K)
Dielectric strength	22 kV/mm
Dielectric constant	4.5

*Strength results will vary depending on the level of surface preparation and gap.

Hot strength



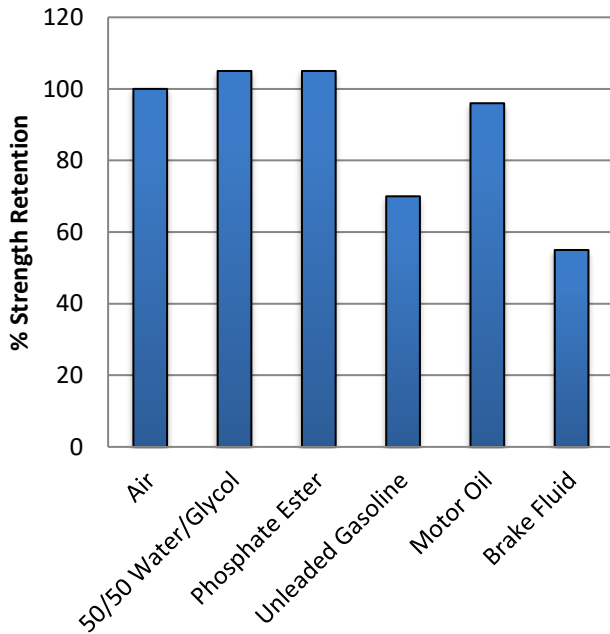
"Hot strength" shear strength tests performed on mild steel. Fully cured then conditioned to pull temperature for 30 minutes before testing.

ES560 can withstand higher temperatures for brief periods (such as for paint baking and wave soldering processes) providing the joint is not unduly stressed. The minimum temperature the cured adhesive can be exposed to is -40°C (-40°F) depending on the materials being bonded.

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Chemical Resistance



Specimens were immersed for 30 days at 85°C and tested at room temperature.

Surface Preparation

Surfaces should be clean, dry and grease-free before applying the adhesive. Use a suitable solvent (such as acetone or isopropanol) for the degreasing of surfaces. Some metals such as aluminium, copper and its alloys will benefit from light abrasion with emery cloth (or similar), to remove the oxide layer.

Directions for Use

- 1) The adhesive should be dispensed from the bottle via the nozzle supplied (this can be cut to give the appropriate sized bead to cover the bond area).
- 2) Apply the adhesive to one surface and avoid entrapping air.
- 3) Assemble parts applying sufficient pressure to ensure the adhesive spreads to cover the entire bond area.
- 4) Use a jig / clamp to prevent parts moving during cure.
- 5) It is advisable not to disturb the joint until the adhesive is fully cured.
- 6) Cure with heat – see page one for cure schedule.

Additional Information

This product is not recommended for use in contact with strong oxidizing materials.

Information regarding the safe handling of this material may be obtained from the safety data sheet (SDS).

Users are reminded that all materials, whether innocuous or not, should be handled in accordance with the principles of good industrial hygiene.

This Technical Datasheet (TDS) offers guideline information and does not constitute a specification.

Storage & Handling

Storage Temperature	2 to 7°C (35 to 45°F)
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Video Links

Surface preparation:

<https://youtu.be/8CMOMP7hXjU>



Single-part epoxy directions for use:

https://youtu.be/_KupaieuuZw



www.permabond.com

- UK: 0800 975 9800
- General Enquiries: +44 (0)1962 711661
- US: 732-868-1372
- Asia: + 86 21 5773 4913

info.europe@permabond.com

info.americas@permabond.com

info.asia@permabond.com

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